

# TDE1737

Interface circuit - relay and lamp-driver

#### Features

- High output current
- Adjustable short-circuit protection
- Thermal protection with hysteresis to avoid the intermediate output levels
- Large supply voltage range: + 8V to +45V

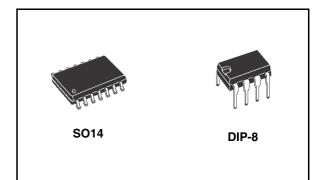
### Description

The TDE1737 is a monolithic amplifier designed for high current and high voltage applications, specifically to drive lamps, relays and control of stepper motors.

This device is essentially blow-out proof. Current limiting is available to limit the peak output current to a safe value, the adjustment only requires one external resistor. In addition, thermal shut down is provided to keep the I.C. from overheating. If internal dissipation becomes too great, the driver will shut down to prevent excessive heating.

The output is also protected against short-circuits with the positive power supply.

The device operates over a wide range of supply voltages from standard  $\pm$  15 V operational amplifier supplies down to the single + 12 V or + 24 used for industrial electronic systems



#### **Order codes**

Part number	Temp range, ° C	Package	Packing
TDE1737DP	-25°C to +85°C	DIP-8	Tube
TDE1737FP	-25°C to +85°C	SO14	Tube
TDE1737FPT	-25°C to +85°C	SO14	Tape and reel

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## 1 Maximum ratings

### 1.1 Absolute maximum ratings

#### Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>S</sub>	Supply Voltage	50	V
Vi	Input Voltage	50	V
VID	Differential Input Voltage	50	V
Ι <sub>Ο</sub>	Output Current	1000	mA
P <sub>tot</sub>	Power Dissipation	Internally Limited	W
Toper	Operating Free-air Temperature Range for TDE1737	– 25 to + 85	°C
T <sub>STG</sub>	Storage Temperature Range	– 65 to + 150	°C

### 1.2 Thermal data

#### Table 2.Thermal data

Symbol	Description	Value	Unit
R <sub>thJA</sub>	Thermal Resistance Junction-ambient (DIP-8) Max.	120	°C/W
R <sub>thJC</sub>	Thermal Resistance Junction-case (DIP-8) Max.	50	°C/W
	Junction-ceramic substrate (case glued to substrate)	90	°C/W



### 2 Electrical characteristics

 $25^{\circ}C \leq T_A \leq +85^{\circ}C, +8V \leq V_{CC} \leq +45 \text{ V}, \text{ I}_O \leq 300 \text{mA}, \text{ } T_J \leq +150^{\circ}C \text{ (unless otherwise specified)}$ 

Symbol	Parameter		Тур.	Max.	Unit
V <sub>IO</sub>	Input Offset Voltage <sup>(1)</sup>	-	2	50	mV
I <sub>IB</sub>	Input Bias Current	-	0.1	1.5	mA
I <sub>CC</sub>	Supply Current ( $V_{CC} = +24V$ , $I_O = 0$ )	-	3	5	mA
VCM	Common-mode Input Voltage Range		_	V <sub>CC</sub> –2	V
ISC	Short–circuit Current Limit ( $R_{SC}$ = 1.5 $\Omega$ T <sub>CASE</sub> = + 25°C)	-	500	-	mA
V <sub>CC</sub> -V <sub>O</sub>	Output Saturation Voltage (output low) ( $V_1^+ - V_1 \leq 50 \text{mV}$ $I_0 = 300 \text{mA}$ , $R_{SC} = 0$ )	Ι	1	1.5	V
I <sub>OL</sub>	Output Leakage Current (output high) ( $V_O = V_{CC} = +24V$ , T <sub>A</sub> = + 25°C)	_	_	10	mA

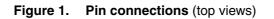
Table 3. Electrical characteristics

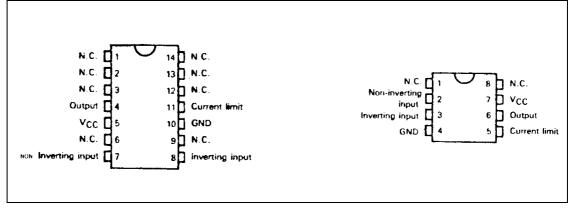
1. The offset voltage given is the maximum value of input voltage required to drive the output voltage within 2V of the ground or the supply voltage.

2. Devices bonded on a 40 cm<sup>2</sup> glass-epoxy printed circuit 0.15cm thick with 4 cm<sup>2</sup> of cooper.

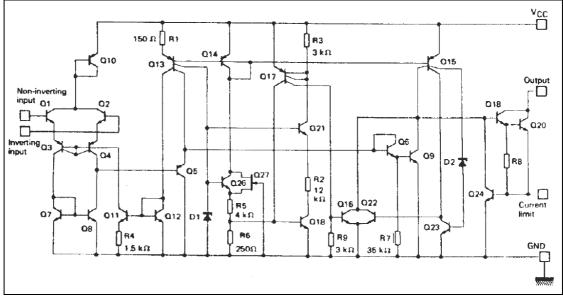


### **3** Pin connections and schematic diagrams

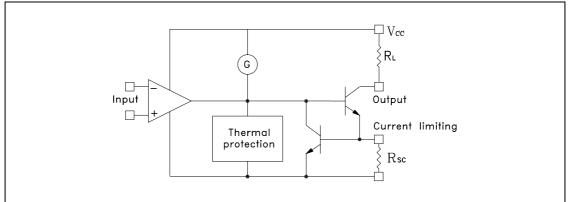




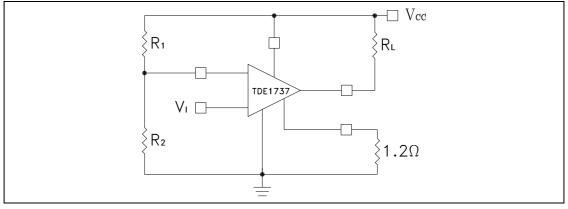




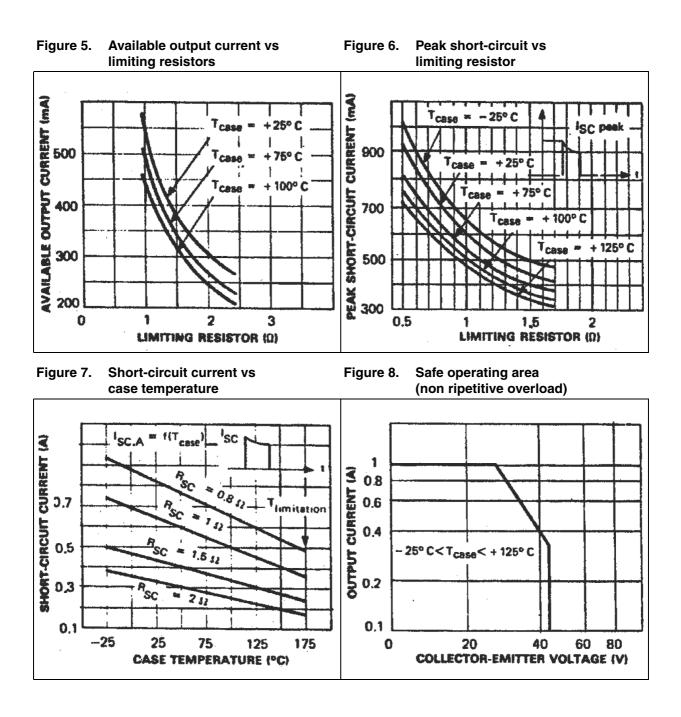
#### Figure 3. Simplified schematic

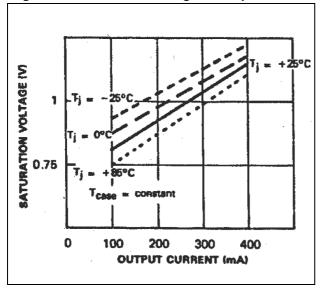


#### Figure 4. Typical application



### 4 **Typical application**





#### Figure 9. Saturation voltage vs output current



### 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

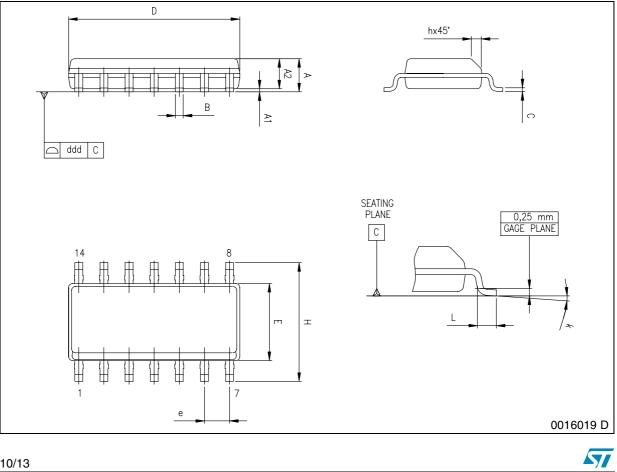


Dim.		mm			Inch		
	Min	Тур	Max	Min	Тур	Max	
A	1.35		1.75	0.053		0.069	
A1	0.10		0.30	0.004		0.012	
A2	1.10		1.65	0.043		0.065	
В	0.33		0.51	0.013		0.020	
С	0.19		0.25	0.007		0.01	
D <sup>(1)</sup>	8.55		8.75	0.337		0.344	
Е	3.80		4.0	0.150		0.157	
е		1.27			0.050		
Н	5.8		6.20	0.228		0.244	
h	0.25		0.50	0.01		0.02	
L	0.40		1.27	0.016		0.050	
k		0° (min.), 8° (max.)					
ddd			0.10			0.004	

#### Table 4. SO14 Mechanical data

1. "D" dimension does not include mold flash, protusions or gate burrs. Mold flash, protusions or gate burrs shall not exceed 0.15mm per side.

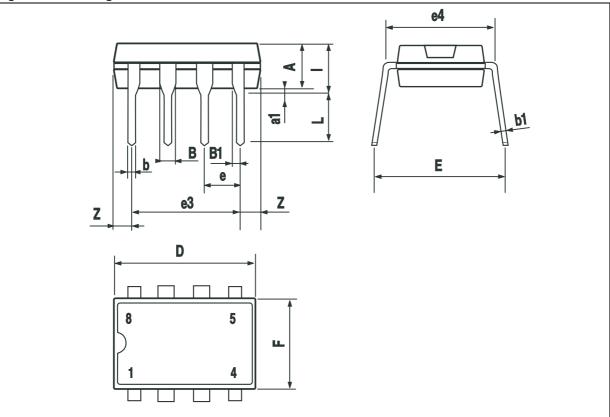




Dim.	mm			Inch		
	Min	Тур	Max	Min	Тур	Max
A		3.32			0.131	
a1	0.51			0.020		
В	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
е		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
I			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

#### Table 5.DIP-8 Mechanical data

#### Figure 11. Package dimensions



# 6 Revision history

Table 6.	Revision	history
	1101131011	matory

Date	Revision	Changes
12-Sep-2003	1	Initial release
20-Oct-2003	2	Few changes
30-May-2006	3	New template



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